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Kind regards,

Team Nexperia

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

Rev. 3 — 4 January 2017

Product data sheet

1. General description

The 74HC161 is a synchronous presettable binary counter with an internal look-head carry. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (CP). The outputs (Q0 to Q3) of the counters may be preset HIGH or LOW. A LOW at the parallel enable input (PE) disables the counting action and causes the data at the data inputs (D0 to D3) to be loaded into the counter on the positive-going edge of the clock. Preset takes place regardless of the levels at count enable inputs (CEP and CET). A LOW at the master reset input (MR) sets Q0 to Q3 LOW regardless of the levels at input pins CP, PE, CET and CEP (thus providing an asynchronous clear function). The look-ahead carry simplifies serial cascading of the counters. Both CEP and CET must be HIGH to count. The CET input is fed forward to enable the terminal count output (TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH output of Q0. This pulse can be used to enable the next cascaded stage. The maximum clock frequency for the cascaded counters is determined by the CP to TC propagation delay and CEP to CP set-up time, according to the following formula:

$$f_{max} = \frac{1}{t_{P(max)}(CPtoTC) + t_{SU}(CEPtoCP)}$$

Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC161: CMOS level
- Synchronous counting and loading
- 2 count enable inputs for n-bit cascading
- Asynchronous reset
- Positive-edge triggered clock
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



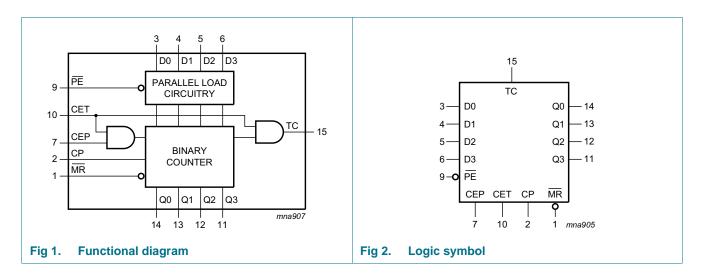
Presettable synchronous 4-bit binary counter; asynchronous reset

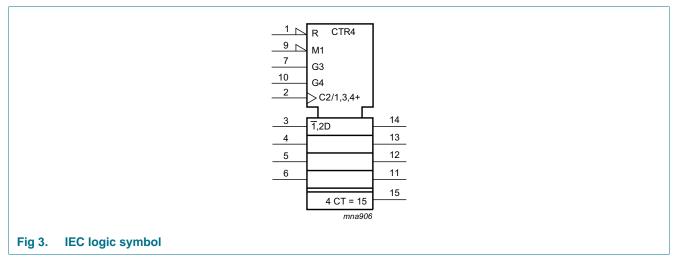
3. Ordering information

Table 1. Ordering information

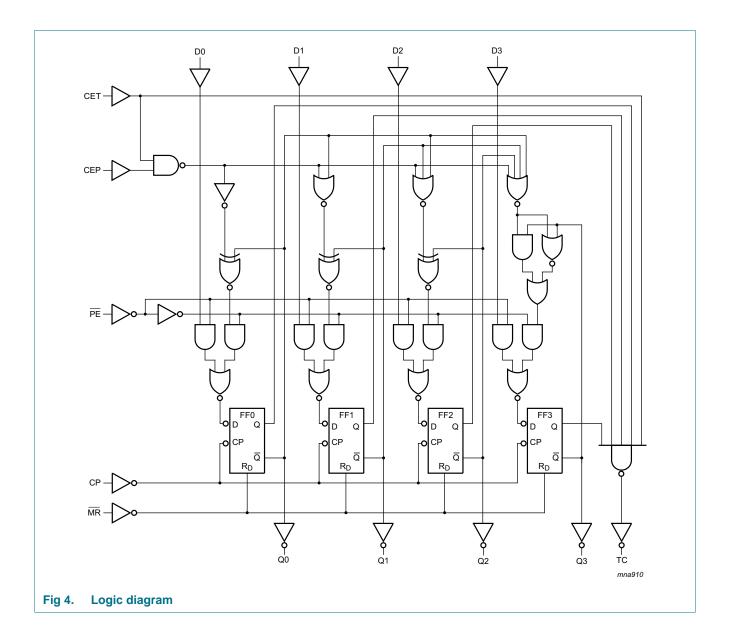
Type number	Package								
	Temperature range	Name	Description	Version					
74HC161D	−40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74HC161DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74HC161PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

4. Functional diagram





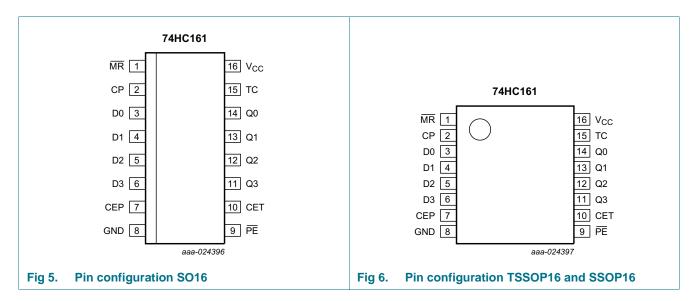
Presettable synchronous 4-bit binary counter; asynchronous reset



Presettable synchronous 4-bit binary counter; asynchronous reset

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
MR	1	asynchronous master reset (active LOW)
СР	2	clock input (LOW-to-HIGH, edge-triggered)
D0, D1, D2, D3	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q0, Q1, Q2, Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V _{CC}	16	supply voltage

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6. Functional description

Table 3. Function table[1]

	Input	Input								
modes	MR	СР	CEP	CET	PE	Dn	Qn	TC		
Reset (clear)	L	X	X	X	X	X	L	L		
Parallel load	Н	↑	Х	X	I	I	L	L		
	Н	↑	Х	X	I	h	Н	[2]		
Count	Н	↑	h	h	h	Х	count	[2]		
Hold	Н	Х	I	Χ	h	Х	q _n	[2]		
(do nothing)	Н	Х	Х	I	h	Х	q _n	L		

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level

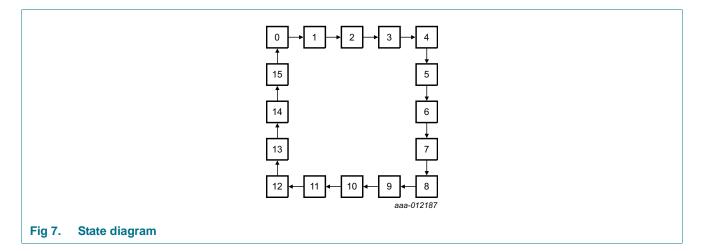
I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

q_n = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition

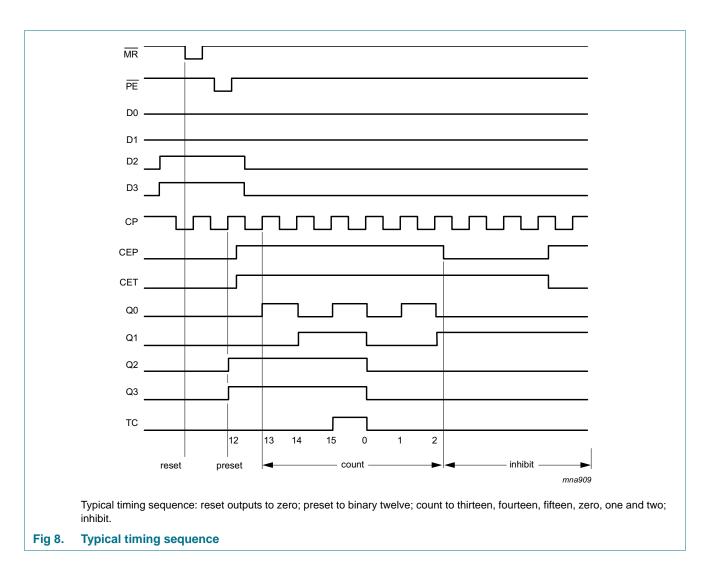
X = don't care

↑ = LOW-to-HIGH clock transition

[2] The TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH)



Presettable synchronous 4-bit binary counter; asynchronous reset



7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _O	output current	$V_O = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO16 package	[1]	-	500	mW
		(T)SSOP16 package	[1]	-	500	mW

^[1] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K. For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

74HC161

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		V _{CC} = 4.5 V	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0$; $V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2$; $V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80.0	-	160.0	μА
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

Presettable synchronous 4-bit binary counter; asynchronous reset

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 14.

Symbol Parameter		Conditions		25 °C		-40 °C to	+85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 9								
	delay	V _{CC} = 2.0 V	-	61	190	-	240	-	285	ns
		V _{CC} = 4.5 V	-	22	38	-	48	-	57	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	19	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	32	-	41	-	48	ns
		CP to TC; see Figure 9								
		V _{CC} = 2.0 V	-	69	215	-	270	-	325	ns
		V _{CC} = 4.5 V	-	25	43	-	54	-	65	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	21	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	20	37	-	46	-	55	ns
		CET to TC; see Figure 10								
		V _{CC} = 2.0 V	-	33	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	12	30	-	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	10	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	10	26	-	38	-	31	ns
t _{PHL}	HIGH to	MR to Qn; see Figure 11								
	LOW propagation	V _{CC} = 2.0 V	-	63	210	-	265	-	315	ns
	delay	V _{CC} = 4.5 V	-	23	42	-	53	-	63	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	36	-	45	-	54	ns
		MR to TC; see Figure 11								
		V _{CC} = 2.0 V	-	63	220	-	275	-	330	ns
		V _{CC} = 4.5 V	-	23	44	-	55	-	66	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	37	-	47	-	56	ns
t _t	transition	see Figure 9 and Figure 10 [2]								
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns

Presettable synchronous 4-bit binary counter; asynchronous reset

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _W	pulse width	CP; HIGH or LOW; see Figure 9								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		MR; LOW; see Figure 11								
		V _{CC} = 2.0 V	80	19	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
t _{rec}	recovery	MR to CP; see Figure 11								
	time	V _{CC} = 2.0 V	100	19	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	6	-	21	-	26	-	ns
t _{su}	set-up time	Dn to CP; see Figure 12								
		V _{CC} = 2.0 V	80	25	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	9	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	7	-	17	-	20	-	ns
		PE to CP; see Figure 12								
		V _{CC} = 2.0 V	100	30	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	11	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	9	-	21	-	26	-	ns
		CEP, CET to CP; see Figure 13								
		V _{CC} = 2.0 V	170	47	-	215	-	255	-	ns
		V _{CC} = 4.5 V	34	17	-	43	-	51	-	ns
		V _{CC} = 6.0 V	29	14	-	37	-	43	-	ns
t _h	hold time	Dn, PE, CEP, CET to CP; see Figure 12 and Figure 13								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0	-	0	-	ns
f _{max}	maximum	CP; see Figure 9								
	frequency	V _{CC} = 2.0 V	4.6	13	-	3.6	-	3.0	-	MHz
		V _{CC} = 4.5 V	23	40	-	18	-	15	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	44	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	27	48	-	21	-	18	-	MHz

Presettable synchronous 4-bit binary counter; asynchronous reset

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see Figure 14.

Symbol	Parameter	Conditions	nditions 25 °C -		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C_{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}; V_{CC} = 5 \text{ V};$ [3] $f_i = 1 \text{ MHz}$	-	33	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [2] t_t is the same as t_{THL} and t_{TLH} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

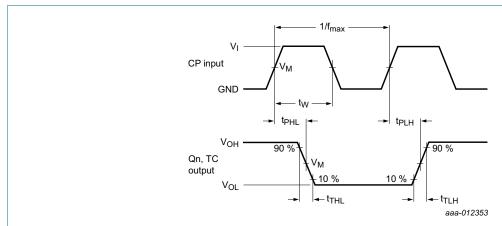
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

11. Waveforms

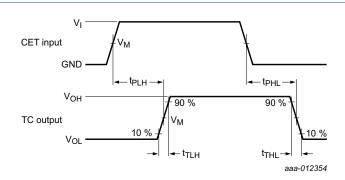


Measurement points are given in Table 8.

Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 9. The clock (CP) to outputs (Qn, TC) propagation delays, pulse width, output transition times and maximum frequency

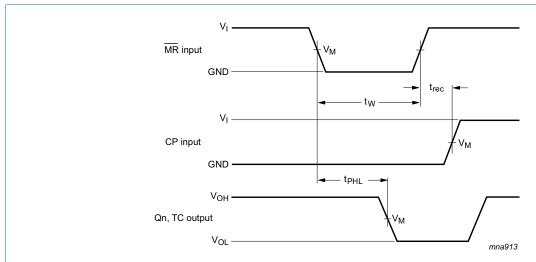
Presettable synchronous 4-bit binary counter; asynchronous reset



Measurement points are given in Table 8.

Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 10. The count enable carry input (CET) to terminal count output (TC) propagation delays and output transition times

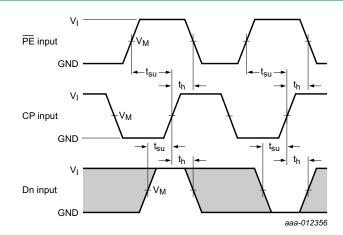


Measurement points are given in Table 8.

Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

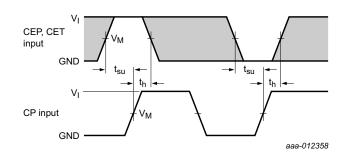
Fig 11. The master reset (MR) pulse width, master reset to output (Qn, TC) propagation delays, and the master reset to clock (CP) recovery times

Presettable synchronous 4-bit binary counter; asynchronous reset



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Fig 12. The data input (Dn) and parallel enable input (PE) set-up and hold times



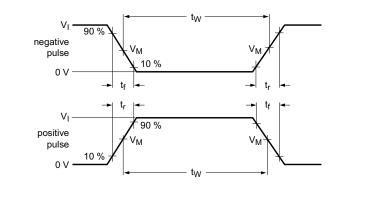
The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

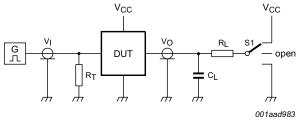
Fig 13. The count enable input (CEP) and count enable carry input (CET) set-up and hold times

Table 8. Measurement points

Input	Output	
V_{M}	V _I	V _M
$0.5 \times V_{CC}$	GND to V _{CC}	0.5 × V _{CC}

Presettable synchronous 4-bit binary counter; asynchronous reset





Test data is given in Table 9.

Test circuit definitions:

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator

 C_L = Load capacitance including jig and probe capacitance

R_L = Load resistance.

S1 = Test selection switch

Fig 14. Test circuit for measuring switching times

Table 9. Test data

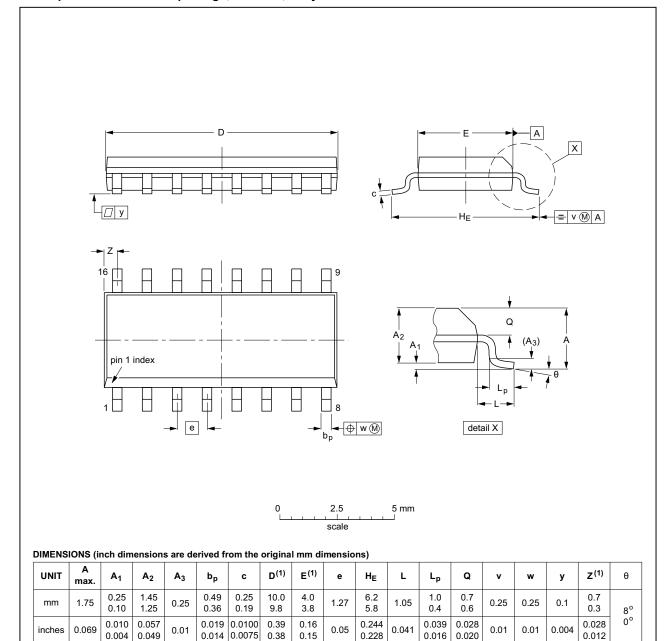
Input		Load	S1 position		
V_l t_r, t_f		CL	R _L	t _{PHL} , t _{PLH}	
V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	

Presettable synchronous 4-bit binary counter; asynchronous reset

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		KEFEK	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	1330E DATE	
SOT109-1	076E07	MS-012			99-12-27 03-02-19	

Fig 15. Package outline SOT109-1 (SO16)

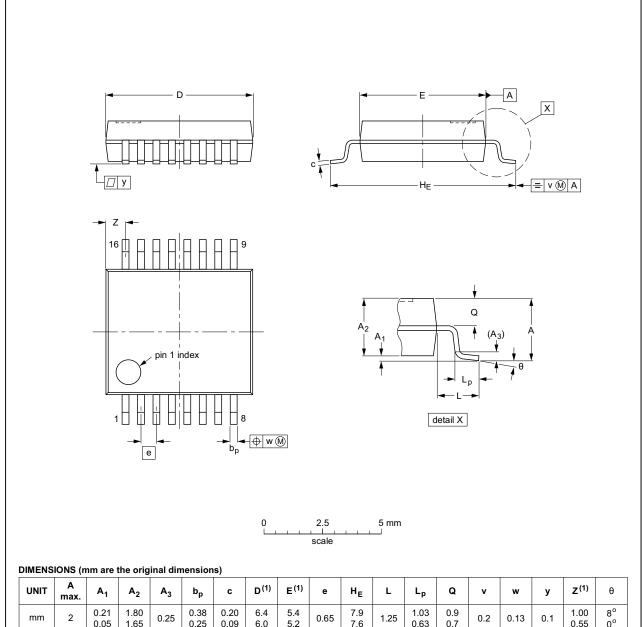
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Presettable synchronous 4-bit binary counter; asynchronous reset

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	C	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT338-1		MO-150				99-12-27 03-02-19
0010001		WIG-100				03-02

Fig 16. Package outline SOT338-1 (SSOP16)

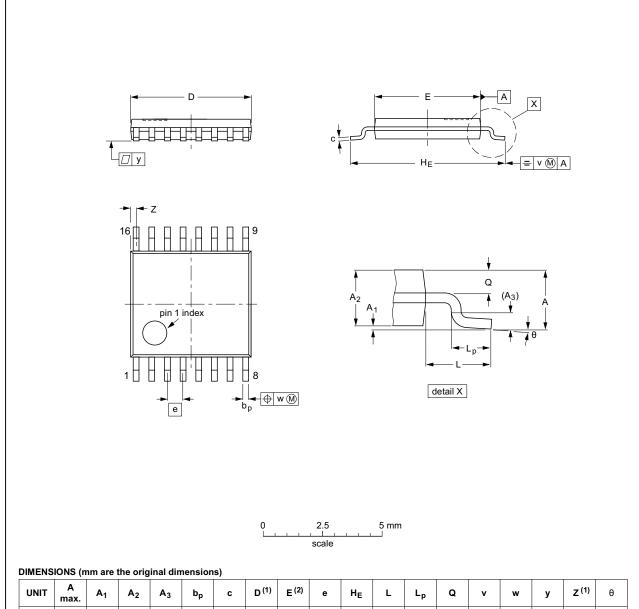
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74HC161 **NXP Semiconductors**

Presettable synchronous 4-bit binary counter; asynchronous reset

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNI	IT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mn	n	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	KEFEK	EUROPEAN	ISSUE DATE			
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
	MO-153				99-12-27 03-02-18	
	IEC	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION	

Fig 17. Package outline SOT403-1 (TSSOP16)

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC161 v.3	20170104	Product data sheet	-	74HC_HCT161 v.2			
Modifications:	 The format of guidelines of I 	th the new identity					
	 Legal texts have been adapted to the new company name where appropriate. 						
	 Type numbers 74HCT161D, 74HCT161DB, 74HCT161PW removed. 						
74HC_HCT161 v.2	19901201	Product specification	-	-			

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15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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